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Details

Product Status	Active
Core Processor	12V1
Core Size	16-Bit
Speed	25MHz
Connectivity	CANbus, IrDA, LINbus, SCI, SPI
Peripherals	LVD, POR, PWM, WDT
Number of I/O	40
Program Memory Size	96KB (96K x 8)
Program Memory Type	FLASH
EEPROM Size	3K x 8
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	3.13V ~ 5.5V
Data Converters	A/D 12x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	48-LQFP
Supplier Device Package	48-LQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/s9s12g96f0mlf

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2.5	PIM Por	rts - Functional Description	
	2.5.1	General	241
	2.5.2	Registers	241
	2.5.3	Pin Configuration Summary	243
	2.5.4	Interrupts	244
2.6	Initializ	ation/Application Information	
	2.6.1	Initialization	246
	2.6.2	Port Data and Data Direction Register writes	246
	2.6.3	Enabling IRQ edge-sensitive mode	246
	2.6.4	ADC External Triggers ETRIG3-0	246
	2.6.5	Emulation of Smaller Packages	

Chapter 3 5V Analog Comparator (ACMPV1)

3.1	Introduction	249
3.2	Features	249
3.3	Block Diagram	249
3.4	External Signals	250
3.5	Modes of Operation	250
3.6	Memory Map and Register Definition	251
	3.6.1 Register Map	251
	3.6.2 Register Descriptions	251
3.7	Functional Description	253

Chapter 4

Reference Voltage Attenuator (RVAV1)

4.1	Introduction	255
4.2	Features	255
4.3	Block Diagram	255
4.4	External Signals	256
4.5	Modes of Operation	256
4.6	Memory Map and Register Definition	257
	4.6.1 Register Map	257
	4.6.2 Register Descriptions	257
4.7	Functional Description	258

Chapter 5

S12G Memory Map Controller (S12GMMCV1)

Introduc	ction	9
5.1.1	Glossary	9
5.1.2	Overview	9
5.1.3	Features	0
5.1.4	Modes of Operation	0
5.1.5	Block Diagram	0
	Introduc 5.1.1 5.1.2 5.1.3 5.1.4 5.1.5	Introduction 25 5.1.1 Glossary 25 5.1.2 Overview 25 5.1.3 Features 26 5.1.4 Modes of Operation 26 5.1.5 Block Diagram 26

	< 0	Fund owestPRIO	ction RITYhighe	Power	Internal Pull Resistor		
Package Pin	Pin	2nd Func.	3rd Func.	4th Func.	Supply	CTRL	Reset State
57	PAD1	KWAD1	AN1	—	V _{DDA}	PER1AD/PPS1AD	Disabled
58	PAD9	KWAD9	AN9	—	V _{DDA}	PER0AD/PPS0AD	Disabled
59	PAD2	KWAD2	AN2	—	V _{DDA}	PER1AD/PPS1AD	Disabled
60	PAD10	KWAD10	AN10	—	V _{DDA}	PER0AD/PPS0AD	Disabled
61	PAD3	KWAD3	AN3	—	V _{DDA}	PER1AD/PPS1AD	Disabled
62	PAD11	KWAD11	AN11		V _{DDA}	PER0AD/PPS0AD	Disabled
63	PAD4	KWAD4	AN4		V _{DDA}	PER1AD/PPS1AD	Disabled
64	PAD12	KWAD12	_		V _{DDA}	PER0AD/PPS0AD	Disabled
65	PAD5	KWAD5	AN5		V _{DDA}	PER1AD/PPS1AD	Disabled
66	PAD13	KWAD13			V _{DDA}	PER0AD/PPS0AD	Disabled
67	PAD6	KWAD6	AN6	_	V _{DDA}	PER1AD/PPS1AD	Disabled
68	PAD14	KWAD14	_		V _{DDA}	PER0AD/PPS0AD	Disabled
69	PAD7	KWAD7	AN7		V _{DDA}	PER1AD/PPS1AD	Disabled
70	PAD15	KWAD15	—	—	V _{DDA}	PER0AD/PPS0AD	Disabled
71	PC4	—	—	—	V _{DDA}	PUCR/PUPCE	Disabled
72	PC5		_	_	V _{DDA}	PUCR/PUPCE	Disabled
73	PC6		—	—	V _{DDA}	PUCR/PUPCE	Disabled
74	PC7		_	_	V _{DDA}	PUCR/PUPCE	Disabled
75	VRH	—	_		_	_	_
76	VDDA	—	—	—	_	_	_
77	VSSA	—	—	—	_	_	_
78	PD0	—	_	_	V _{DDX}	PUCR/PUPDE	Disabled
79	PD1	—	—	—	V _{DDX}	PUCR/PUPDE	Disabled
80	PD2	—	_		V _{DDX}	PUCR/PUPDE	Disabled
81	PD3	—	—	—	V _{DDX}	PUCR/PUPDE	Disabled
82	PS0	RXD0	—	—	V _{DDX}	PERS/PPSS	Up
83	PS1	TXD0	—	_	V _{DDX}	PERS/PPSS	Up
84	PS2	RXD1	—	_	V _{DDX}	PERS/PPSS	Up
85	PS3	TXD1	_		V _{DDX}	PERS/PPSS	Up

Table 1-25.	100-Pin LQFP	Pinout for	S12GA96	and S12GA128
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		<lowest< th=""><th>Function PRIORITY</th><th>Power</th><th>Internal P Resisto</th><th>ull r</th></lowest<>	Function PRIORITY	Power	Internal P Resisto	ull r		
Package Pin	Pin	2nd Func.	3rd Func.	4th Func	5th Func	Supply	CTRL	Reset State
2	VDDXR		_		_	—	_	_
3	VSSX		—	—	_	—	_	_
4	PE0 ¹	EXTAL	—	_	_	V _{DDX}	PUCR/PDPEE	Down
5	VSS	_	—	_	_	—	_	_
6	PE1 ¹	XTAL	_	_	_	V _{DDX}	PUCR/PDPEE	Down
7	TEST	_	—		_	N.A.	RESET pin	Down
8	PJ0	KWJ0	PWM6	MISO1	_	V _{DDX}	PERJ/PPSJ	Up
9	PJ1	KWJ1	IOC6	MOSI1	_	V _{DDX}	PERJ/PPSJ	Up
10	PJ2	KWJ2	IOC7	SCK1	_	V _{DDX}	PERJ/PPSJ	Up
11	PJ3	KWJ3	PWM7	SS1	_	V _{DDX}	PERJ/PPSJ	Up
12	BKGD	MODC	—		_	V _{DDX}	PUCR/BKPUE	Up
13	PP0	KWP0	ETRIG0	API_EXTC LK	PWM0	V _{DDX}	PERP/PPSP	Disabled
14	PP1	KWP1	ETRIG1	ECLKX2	PWM1	V _{DDX}	PERP/PPSP	Disabled
15	PP2	KWP2	ETRIG2	PWM2	_	V _{DDX}	PERP/PPSP	Disabled
16	PP3	KWP3	ETRIG3	PWM3	_	V _{DDX}	PERP/PPSP	Disabled
17	PP4	KWP4	PWM4		_	V _{DDX}	PERP/PPSP	Disabled
18	PP5	KWP5	PWM5		_	V _{DDX}	PERP/PPSP	Disabled
19	PT5	IOC5	_		_	V _{DDX}	PERT/PPST	Disabled
20	PT4	IOC4	_		_	V _{DDX}	PERT/PPST	Disabled
21	PT3	IOC3	_		_	V _{DDX}	PERT/PPST	Disabled
22	PT2	IOC2	_		_	V _{DDX}	PERT/PPST	Disabled
23	PT1	IOC1	IRQ		_	V _{DDX}	PERT/PPST	Disabled
24	PT0	IOC0	XIRQ	_	_	V _{DDX}	PERT/PPST	Disabled
25	PAD0	KWAD0	AN0	—		V _{DDA}	PER1AD/PPS1AD	Disabled
26	PAD8	KWAD8	AN8	—	—	V _{DDA}	PER0AD/PPS0AD	Disabled
27	PAD1	KWAD1	AN1	_	—	V _{DDA}	PER1AD/PPS1AD	Disabled
28	PAD9	KWAD9	AN9	—	—	V _{DDA}	PER0AD/PPS0AD	Disabled
29	PAD2	KWAD2	AN2	—	—	V _{DDA}	PER1AD/PPS1AD	Disabled

Table 1-26. 48-Pin LQFP Pinout for S12G192 and S12G240

1.17 ADC Result Reference

MCUs of the S12G-Family are able to measure the internal reference voltage V_{DDF} (see Table 1-38). V_{DDF} is a constant voltage with a narrow distribution over temperature and external voltage supply (see Table A-47).

A 12-bit left justified¹ ADC conversion result of V_{DDF} is provided at address $0x0_4022/0x0_4023$ in the NVM's IFR for reference. The measurement conditions of the reference conversion are listed in Section A.16, "ADC Conversion Result Reference". By measuring the voltage V_{DDF} (see Table 1-38) and comparing the result to the reference value in the IFR, it is possible to determine the ADC's reference voltage V_{RH} in the application environment:

 $V_{RH} = \frac{StoredReference}{ConvertedReference} \bullet 5V$

The exact absolute value of an analog conversion can be determined as follows:

 $Result = ConvertedADInput \bullet \frac{StoredReference \bullet 5V}{ConvertedReference \bullet 2^{n}}$

With:

ConvertedADInput:Result of the analog to digital conversion of the desired pinConvertedReference:Result of channel "Internal_0" conversionStoredReference:Value in IFR locatio 0x0_4022/0x0_4023n:ADC resolution (10 bit)

CAUTION

To assure high accuracy of the V_{DDF} reference conversion, the NVMs must not be programmed, erased, or read while the conversion takes place. This implies that code must be executed from RAM. The "ConvertedReference" value must be the average of eight consecutive conversions.

CAUTION

The ADC's reference voltage V_{RH} must remain at a constant level throughout the conversion process.

1.18 ADC VRH/VRL Signal Connection

On all S12G devices except for the S12GA192 and the S12GA240 the external VRH signal is directly connected to the ADC's VRH signal input. The ADC's VRL input is connected to VSSA. (see Figure 1-27).

1. The format of the stored $\mathsf{V}_{\mathsf{DDF}}$ reference value is still subject to change.

The S12GA192 and the S12GA240 contain a Reference Voltage Attenuator (RVA) module. The connection of the ADC's VRH/VRL inputs on these devices is shown in Figure 1-27.



S12GA192, S12GA240



Figure 1-27. ADC VRH/VRL Signal Connection

1.19 BDM Clock Source Connectivity

The BDM clock is mapped to the VCO clock divided by 8.



Figure 5-11. Local to Global Address Mapping

5.4.3 Unimplemented and Reserved Address Ranges

The S12GMMC is capable of mapping up 240K of flash, up to 4K of EEPROM and up to 11K of RAM into the global memory map. Smaller devices of the S12G-family do not utilize all of the available address space. Address ranges which are not associated with one of the on-chip memories fall into two categories: Unimplemented addresses and reserved addresses.

Unimplemented addresses are not mapped to any of the on-chip memories. The S12GMMC is aware that accesses to these address location have no destination and triggers a system reset (illegal address reset) whenever they are attempted by the CPU. The BDM is not able to trigger illegal address resets.

Reserved addresses are associated with a memory block on the device, even though the memory block does not contain the resources to fill the address space. The S12GMMC is not aware that the associated memory does not physically exist. It does not trigger an illegal address reset when accesses to reserved locations are attempted.



Table 5-8 shows the global address ranges of all members of the S12G-family.

Table 5-8. Global Address Ranges

Table 7-6. Firmware Commands						
Command ¹ Opcode Data		Data	Description			
READ_NEXT ²	62	16-bit data out	Increment X index register by 2 (X = X + 2), then read word X points to.			
READ_PC	63	16-bit data out	Read program counter.			
READ_D	64	16-bit data out	Read D accumulator.			
READ_X	65	16-bit data out	Read X index register.			
READ_Y	66	16-bit data out	Read Y index register.			
READ_SP	67	16-bit data out	Read stack pointer.			
WRITE_NEXT ²	42	16-bit data in	Increment X index register by 2 (X = X + 2), then write word to location pointed to by X.			
WRITE_PC	43	16-bit data in	Write program counter.			
WRITE_D	44	16-bit data in	Write D accumulator.			
WRITE_X	45	16-bit data in	Write X index register.			
WRITE_Y	46	16-bit data in	Write Y index register.			
WRITE_SP	47	16-bit data in	Write stack pointer.			
GO	08	none	Go to user program. If enabled, ACK will occur when leaving active background mode.			
GO_UNTIL ³	0C	none	Go to user program. If enabled, ACK will occur upon returning to active background mode.			
TRACE1	10	none	Execute one user instruction then return to active BDM. If enabled, ACK will occur upon returning to active background mode.			
TAGGO -> GO	18	none	(Previous enable tagging and go to user program.)			

If enabled, ACK will occur when data is ready for transmission for all BDM READ commands and will occur after the write is complete for all BDM WRITE commands.

Opcode will be executed as a GO command.

This command will be deprecated and should not be used anymore.

2 When the firmware command READ NEXT or WRITE NEXT is used to access the BDM address space the BDM resources are accessed rather than user code. Writing BDM firmware is not possible.

3 System stop disables the ACK function and ignored commands will not have an ACK-pulse (e.g., CPU in stop or wait mode). The GO UNTIL command will not get an Acknowledge if CPU executes the wait or stop instruction before the "UNTIL" condition (BDM active again) is reached (see Section 7.4.7, "Serial Interface Hardware Handshake Protocol" last note).

7.4.5 **BDM Command Structure**

Hardware and firmware BDM commands start with an 8-bit opcode followed by a 16-bit address and/or a 16-bit data word, depending on the command. All the read commands return 16 bits of data despite the byte or word implication in the command name.

> 8-bit reads return 16-bits of data, only one byte of which contains valid data. If reading an even address, the valid data will appear in the MSB. If reading an odd address, the valid data will appear in the LSB.

> > MC9S12G Family Reference Manual Rev.1.27

7.4.7 Serial Interface Hardware Handshake Protocol

BDM commands that require CPU execution are ultimately treated at the MCU bus rate. Since the BDM clock source can be modified when changing the settings for the VCO frequency (CPMUSYNR), it is very helpful to provide a handshake protocol in which the host could determine when an issued command is executed by the CPU. The BDM clock frequency is always VCO frequency divided by 8. The alternative is to always wait the amount of time equal to the appropriate number of cycles at the slowest possible rate the clock could be running. This sub-section will describe the hardware handshake protocol.

The hardware handshake protocol signals to the host controller when an issued command was successfully executed by the target. This protocol is implemented by a 16 serial clock cycle low pulse followed by a brief speedup pulse in the BKGD pin. This pulse is generated by the target MCU when a command, issued by the host, has been successfully executed (see Figure 7-10). This pulse is referred to as the ACK pulse. After the ACK pulse has finished: the host can start the bit retrieval if the last issued command was a read command, or start a new command if the last command was a write command or a control command (BACKGROUND, GO, GO_UNTIL or TRACE1). The ACK pulse is not issued earlier than 32 serial clock cycles after the BDM command was issued. The end of the BDM command is assumed to be the 16th tick of the last bit. This minimum delay assures enough time for the host to perceive the ACK pulse. Note also that, there is no upper limit for the delay between the command and the related ACK pulse, since the command execution depends upon the CPU bus, which in some cases could be very slow due to long accesses taking place. This protocol allows a great flexibility for the POD designers, since it does not rely on any accurate time measurement or short response time to any event in the serial communication.



Figure 7-10. Target Acknowledge Pulse (ACK)

NOTE

If the ACK pulse was issued by the target, the host assumes the previous command was executed. If the CPU enters wait or stop prior to executing a hardware command, the ACK pulse will not be issued meaning that the BDM command was not executed. After entering wait or stop mode, the BDM command is no longer pending.

13.3.2.12.2 Right Justified Result Data (DJM=1)

Module Base + 0x0010 = ATDDR0, 0x0012 = ATDDR1, 0x0014 = ATDDR2, 0x0016 = ATDDR3 0x0018 = ATDDR4, 0x001A = ATDDR5, 0x001C = ATDDR6, 0x001E = ATDDR7 0x0020 = ATDDR8, 0x0022 = ATDDR9, 0x0024 = ATDDR10, 0x0026 = ATDDR11



Figure 13-15. Right justified ATD conversion result register (ATDDRn)

Table 13-22 shows how depending on the A/D resolution the conversion result is transferred to the ATD result registers for right justified data. Compare is always done using all 12 bits of both the conversion result and the compare value in ATDDRn.

A/D resolution	DJM	conversion result mapping to ATDDR <i>n</i>
8-bit data	1	Result-Bit[11:8]=0000, Result-Bit[7:0] = conversion result
10-bit data	1	Result-Bit[11:10]=00, Result-Bit[9:0] = conversion result

Table 13-22. Conversion result mapping to ATDDRn

• The channel is disabled

In this way, the output of the PWM will always be either the old duty waveform or the new duty waveform, not some variation in between. If the channel is not enabled, then writes to the duty register will go directly to the latches as well as the buffer.

NOTE

Reads of this register return the most recent value written. Reads do not necessarily return the value of the currently active duty due to the double buffering scheme.

See Section 19.4.2.3, "PWM Period and Duty" for more information.

NOTE

Depending on the polarity bit, the duty registers will contain the count of either the high time or the low time. If the polarity bit is one, the output starts high and then goes low when the duty count is reached, so the duty registers contain a count of the high time. If the polarity bit is zero, the output starts low and then goes high when the duty count is reached, so the duty registers contain a count of the low time.

To calculate the output duty cycle (high time as a% of period) for a particular channel:

• Polarity = 0 (PPOL x =0)

Duty Cycle = [(PWMPERx-PWMDTYx)/PWMPERx] * 100%

• Polarity = 1 (PPOLx = 1)

Duty Cycle = [PWMDTYx / PWMPERx] * 100%

For boundary case programming values, please refer to Section 19.4.2.8, "PWM Boundary Cases".

Module Base + 0x001C = PWMDTY0, 0x001D = PWMDTY1, 0x001E = PWMDTY2, 0x001F = PWMDTY3 Module Base + 0x0020 = PWMDTY4, 0x0021 = PWMDTY5, 0x0022 = PWMDTY6, 0x0023 = PWMDTY7

_	7	6	5	4	3	2	1	0
R W	Bit 7	6	5	4	3	2	1	Bit 0
Reset	1	1	1	1	1	1	1	1

Figure 19-14. PWM Channel Duty Registers (PWMDTYx)

¹ This register is available only when the corresponding channel exists and is reserved if that channel does not exist. Writes to a reserved register have no functional effect. Reads from a reserved register return zeroes.

Read: Anytime

Write: Anytime

Field	Description
7 TDRE	 Transmit Data Register Empty Flag — TDRE is set when the transmit shift register receives a byte from the SCI data register. When TDRE is 1, the transmit data register (SCIDRH/L) is empty and can receive a new value to transmit.Clear TDRE by reading SCI status register 1 (SCISR1), with TDRE set and then writing to SCI data register low (SCIDRL). 0 No byte transferred to transmit shift register 1 Byte transferred to transmit shift register; transmit data register empty
6 TC	 Transmit Complete Flag — TC is set low when there is a transmission in progress or when a preamble or break character is loaded. TC is set high when the TDRE flag is set and no data, preamble, or break character is being transmitted. When TC is set, the TXD pin becomes idle (logic 1). Clear TC by reading SCI status register 1 (SCISR1) with TC set and then writing to SCI data register low (SCIDRL). TC is cleared automatically when data, preamble, or break is queued and ready to be sent. TC is cleared in the event of a simultaneous set and clear of the TC flag (transmission not complete). 0 Transmission in progress 1 No transmission in progress
5 RDRF	 Receive Data Register Full Flag — RDRF is set when the data in the receive shift register transfers to the SCI data register. Clear RDRF by reading SCI status register 1 (SCISR1) with RDRF set and then reading SCI data register low (SCIDRL). 0 Data not available in SCI data register 1 Received data available in SCI data register
4 IDLE	 Idle Line Flag — IDLE is set when 10 consecutive logic 1s (if M = 0) or 11 consecutive logic 1s (if M = 1) appear on the receiver input. Once the IDLE flag is cleared, a valid frame must again set the RDRF flag before an idle condition can set the IDLE flag.Clear IDLE by reading SCI status register 1 (SCISR1) with IDLE set and then reading SCI data register low (SCIDRL). 0 Receiver input is either active now or has never become active since the IDLE flag was last cleared 1 Receiver input has become idle Note: When the receiver wakeup bit (RWU) is set, an idle line condition does not set the IDLE flag.
3 OR	 Overrun Flag — OR is set when software fails to read the SCI data register before the receive shift register receives the next frame. The OR bit is set immediately after the stop bit has been completely received for the second frame. The data in the shift register is lost, but the data already in the SCI data registers is not affected. Clear OR by reading SCI status register 1 (SCISR1) with OR set and then reading SCI data register low (SCIDRL). 0 No overrun 1 Overrun Note: OR flag may read back as set when RDRF flag is clear. This may happen if the following sequence of events occurs: After the first frame is received, read status register SCISR1 (returns RDRF set and OR flag clear); Receive second frame without reading the first frame in the data register (the second frame is not received and OR flag is set); Read data register SCIDRL (returns RDRF clear and OR set). Event 3 may be at exactly the same time as event 2 or any time after. When this happens, a dummy SCIDRL read following event 4 will be required to clear the OR flag if further frames are to be received.
2 NF	 Noise Flag — NF is set when the SCI detects noise on the receiver input. NF bit is set during the same cycle as the RDRF flag but does not get set in the case of an overrun. Clear NF by reading SCI status register 1(SCISR1), and then reading SCI data register low (SCIDRL). 0 No noise 1 Noise

Table 20-11. SCISR1 Field Descriptions

Field	Description
3 RXPOL	 Receive Polarity — This bit control the polarity of the received data. In NRZ format, a one is represented by a mark and a zero is represented by a space for normal polarity, and the opposite for inverted polarity. In IrDA format, a zero is represented by short high pulse in the middle of a bit time remaining idle low for a one for normal polarity, and a zero is represented by short low pulse in the middle of a bit time remaining idle high for a one for inverted polarity. 0 Normal polarity 1 Inverted polarity
2 BRK13	 Break Transmit Character Length — This bit determines whether the transmit break character is 10 or 11 bit respectively 13 or 14 bits long. The detection of a framing error is not affected by this bit. 0 Break character is 10 or 11 bit long 1 Break character is 13 or 14 bit long
1 TXDIR	 Transmitter Pin Data Direction in Single-Wire Mode — This bit determines whether the TXD pin is going to be used as an input or output, in the single-wire mode of operation. This bit is only relevant in the single-wire mode of operation. 0 TXD pin to be used as an input in single-wire mode 1 TXD pin to be used as an output in single-wire mode
0 RAF	 Receiver Active Flag — RAF is set when the receiver detects a logic 0 during the RT1 time period of the start bit search. RAF is cleared when the receiver detects an idle character. 0 No reception in progress 1 Reception in progress

20.3.2.9 SCI Data Registers (SCIDRH, SCIDRL)

Module Base + 0x0006



Figure 20-12. SCI Data Registers (SCIDRH)

Module Base + 0x0007

	7	6	5	4	3	2	1	0
R	R7	R6	R5	R4	R3	R2	R1	R0
W	T7	Т6	T5	T4	Т3	T2	T1	Т0
Reset	0	0	0	0	0	0	0	0

Figure 20-13. SCI Data Registers (SCIDRL)

Read: Anytime; reading accesses SCI receive data register

Write: Anytime; writing accesses SCI transmit data register; writing to R8 has no effect

SPPR2	SPPR1	SPPR0	SPR2	SPR1	SPR0	Baud Rate Divisor	Baud Rate
0	0	1	0	1	0	16	1.5625 Mbit/s
0	0	1	0	1	1	32	781.25 kbit/s
0	0	1	1	0	0	64	390.63 kbit/s
0	0	1	1	0	1	128	195.31 kbit/s
0	0	1	1	1	0	256	97.66 kbit/s
0	0	1	1	1	1	512	48.83 kbit/s
0	1	0	0	0	0	6	4.16667 Mbit/s
0	1	0	0	0	1	12	2.08333 Mbit/s
0	1	0	0	1	0	24	1.04167 Mbit/s
0	1	0	0	1	1	48	520.83 kbit/s
0	1	0	1	0	0	96	260.42 kbit/s
0	1	0	1	0	1	192	130.21 kbit/s
0	1	0	1	1	0	384	65.10 kbit/s
0	1	0	1	1	1	768	32.55 kbit/s
0	1	1	0	0	0	8	3.125 Mbit/s
0	1	1	0	0	1	16	1.5625 Mbit/s
0	1	1	0	1	0	32	781.25 kbit/s
0	1	1	0	1	1	64	390.63 kbit/s
0	1	1	1	0	0	128	195.31 kbit/s
0	1	1	1	0	1	256	97.66 kbit/s
0	1	1	1	1	0	512	48.83 kbit/s
0	1	1	1	1	1	1024	24.41 kbit/s
1	0	0	0	0	0	10	2.5 Mbit/s
1	0	0	0	0	1	20	1.25 Mbit/s
1	0	0	0	1	0	40	625 kbit/s
1	0	0	0	1	1	80	312.5 kbit/s
1	0	0	1	0	0	160	156.25 kbit/s
1	0	0	1	0	1	320	78.13 kbit/s
1	0	0	1	1	0	640	39.06 kbit/s
1	0	0	1	1	1	1280	19.53 kbit/s
1	0	1	0	0	0	12	2.08333 Mbit/s
1	0	1	0	0	1	24	1.04167 Mbit/s
1	0	1	0	1	0	48	520.83 kbit/s
1	0	1	0	1	1	96	260.42 kbit/s
1	0	1	1	0	0	192	130.21 kbit/s
1	0	1	1	0	1	384	65.10 kbit/s
1	0	1	1	1	0	768	32.55 kbit/s
1	0	1	1	1	1	1536	16.28 kbit/s
1	1	0	0	0	0	14	1.78571 Mbit/s

Table 21-6. Example SPI Baud Rate Selection (25 MHz Bus Clock)



Figure 22-22. Detailed Timer Block Diagram

22.4.1 Prescaler

The prescaler divides the Bus clock by 1, 2, 4, 8, 16, 32, 64 or 128. The prescaler select bits, PR[2:0], select the prescaler divisor. PR[2:0] are in timer system control register 2 (TSCR2).

The prescaler divides the Bus clock by a prescalar value. Prescaler select bits PR[2:0] of in timer system control register 2 (TSCR2) are set to define a prescalar value that generates a divide by 1, 2, 4, 8, 16, 32, 64 and 128 when the PRNT bit in TSCR1 is disabled.



Figure 24-1. FTMRG16K1 Block Diagram

24.2 External Signal Description

The Flash module contains no signals that connect off-chip.

64 KByte Flash Module (S12FTMRG64K1V1)

Table 27-4). The Verify Backdoor Access Key command must not be executed from the Flash block containing the backdoor comparison key to avoid code runaway.

CCOBIX[2:0]	FCCOB Parameters					
000	0x0C	Not required				
001	Key 0					
010	Key 1					
011	Key 2					
100	Key 3					

Table 27-52. Verify Backdoor Access Key Command FCCOB Requirements

Upon clearing CCIF to launch the Verify Backdoor Access Key command, the Memory Controller will check the FSEC KEYEN bits to verify that this command is enabled. If not enabled, the Memory Controller sets the ACCERR bit in the FSTAT register and terminates. If the command is enabled, the Memory Controller compares the key provided in FCCOB to the backdoor comparison key in the Flash configuration field with Key 0 compared to 0x3_FF00, etc. If the backdoor keys match, security will be released. If the backdoor keys do not match, security is not released and all future attempts to execute the Verify Backdoor Access Key command are aborted (set ACCERR) until a reset occurs. The CCIF flag is set after the Verify Backdoor Access Key operation has completed.

Table 27-53. Verify Backdoor Access Key Command Error Handling

Register	Error Bit	Error Condition
		Set if CCOBIX[2:0] != 100 at command launch
		Set if an incorrect backdoor key is supplied
	ACCERR	Set if backdoor key access has not been enabled (KEYEN[1:0] != 10, see Section 27.3.2.2)
FSTAT		Set if the backdoor key has mismatched since the last reset
	FPVIOL	None
	MGSTAT1	None
	MGSTAT0	None

27.4.6.12 Set User Margin Level Command

The Set User Margin Level command causes the Memory Controller to set the margin level for future read operations of the P-Flash or EEPROM block.

CCOBIX[2:0]	FCCOB Parameters				
000	0x0D Flash block selection code [1:0]. See Table 27-34				
001	Margin level setting.				

96 KByte Flash Module (S12FTMRG96K1V1)

P-Flash memory (see Table 28-4) as indicated by reset condition F in Table 28-23. To change the EEPROM protection that will be loaded during the reset sequence, the P-Flash sector containing the EEPROM protection byte must be unprotected, then the EEPROM protection byte must be programmed. If a double bit fault is detected while reading the P-Flash phrase containing the EEPROM protection byte during the reset sequence, the DPOPEN bit will be cleared and DPS bits will be set to leave the EEPROM memory fully protected.

Trying to alter data in any protected area in the EEPROM memory will result in a protection violation error and the FPVIOL bit will be set in the FSTAT register. Block erase of the EEPROM memory is not possible if any of the EEPROM sectors are protected.

Field	Description
7 DPOPEN	 EEPROM Protection Control Enables EEPROM memory protection from program and erase with protected address range defined by DPS bits Disables EEPROM memory protection from program and erase
6–0 DPS[6:0]	EEPROM Protection Size — The DPS[6:0] bits determine the size of the protected area in the EEPROM memory, this size increase in step of 32 bytes, as shown in Table 28-23.

Table 28-22.	EEPROT	Field I	Descriptions
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Table 28-23. EEPROM Protection Address Range

DPS[6:0]	Global Address Range	Protected Size			
0000000	0x0_0400 - 0x0_041F	32 bytes			
0000001	0x0_0400 - 0x0_043F	64 bytes			
0000010	0x0_0400 – 0x0_045F	96 bytes			
0000011	0x0_0400 – 0x0_047F	128 bytes			
0000100	0x0_0400 - 0x0_049F	160 bytes			
0000101	0x0_0400 – 0x0_04BF	192 bytes			
The Protection Size goes on enlarging in step of 32 bytes, for each DPS value increasing of one.					
1011111 - to - 1111111	0x0_0400 – 0x0_0FFF	3,072 bytes			

S12G9	S12G96, S12GA96, S12G128, S12GA128								
Num	Command	f _{NVMOP} cycle	f _{NVMBUS} cycle	Symbol	Min ¹	Typ ²	Max ³	Lfmax ⁴	Unit
1	Erase Verify All Blocks ^{5,6}	0	35345	t _{RD1ALL}	1.41	1.41	2.83	70.69	ms
2	Erase Verify Block (Pflash) ⁵	0	33308	t _{RD1BLK_P}	1.33	1.33	2.66	66.62	ms
3	Erase Verify Block (EEPROM) ⁶	0	2536	t _{RD1BLK_} D	0.1	0.1	0.2	5.07	ms
4	Erase Verify P-Flash Section	0	476	t _{RD1SEC}	19.04	19.04	38.08	952	ms
5	Read Once	0	445	t _{RDONCE}	17.8	17.8	17.8	445	μS
6	Program P-Flash (4 Word)	164	2925	t _{PGM_4}	0.27	0.28	0.63	11.91	ms
7	Program Once	164	2888	t _{PGMONCE}	0.27	0.28	0.28	3.09	ms
8	Erase All Blocks ^{5,6}	100066	35681	t _{ERSALL}	96.73	101.49	102.92	196.44	ms
9	Erase Flash Block (Pflash) ⁵	100060	33541	t _{ERSBLK_P}	96.64	101.4	102.74	192.16	ms
10	Erase Flash Block (EEPROM) ⁶	100060	2832	t _{ERSBLK_D}	95.41	100.17	100.29	130.74	ms
11	Erase P-Flash Sector	20015	865	t _{ERSPG}	19.1	20.05	20.08	26.75	ms
12	Unsecure Flash	100066	35759	t _{UNSECU}	96.73	101.5	102.93	196.6	ms
13	Verify Backdoor Access Key	0	481	t _{VFYKEY}	19.24	19.24	19.24	481	μS
14	Set User Margin Level	0	399	t _{MLOADU}	15.96	15.96	15.96	399	μS
15	Set Factory Margin Level	0	408	t _{MLOADF}	16.32	16.32	16.32	408	μS
16	Erase Verify EEPROM Section	0	546	t _{DRD1SEC}	0.02	0.02	0.04	1.09	ms
17	Program EEPROM (1 Word)	68	1565	t _{DPGM_1}	0.13	0.13	0.32	6.35	ms
18	Program EEPROM (2 Word)	136	2512	t _{DPGM_2}	0.23	0.24	0.54	10.22	ms
19	Program EEPROM (3 Word)	204	3459	t _{DPGM_3}	0.33	0.34	0.76	14.09	ms
20	Program EEPROM (4 Word)	272	4406	t _{DPGM_4}	0.44	0.45	0.98	17.96	ms
21	Erase EEPROM Sector	5015	753	t _{DERSPG}	4.81	5.05	20.57	37.88	ms

Table A-37. NVM Timing Characteristics)

 $^1\,$ Minimum times are based on maximum f_{NVMOP} and maximum f_{NVMBUS}

 $^2\,$ Typical times are based on typical f_{NVMOP} and typical f_{NVMBUS}

 $^3\,$ Maximum times are based on typical $f_{\rm NVMOP}$ and typical $f_{\rm NVMBUS}$ plus aging

 4 Lowest-frequency max times are based on minimum $f_{\rm NVMOP}$ and minimum $f_{\rm NVMBUS}$ plus aging

⁵ Affected by Pflash size

⁶ Affected by EEPROM size

Detailed Register Address Map

0x0040–0x067 Timer Module (TIM)

0x0050	TCxH – TCxL	R W	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8
0x005F		R W	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0x0060	PACTL	R W	0	PAEN	PAMOD	PEDGE	CLK1	CLK0	PAOVI	PAI
0x0061	PAFLG	R W	0	0	0	0	0	0	PAOVF	PAIF
0x0062	PACNTH	R W	PACNT15	PACNT14	PACNT13	PACNT12	PACNT11	PACNT10	PACNT9	PACNT8
0x0063	PACNTL	R W	PACNT7	PACNT6	PACNT5	PACNT4	PACNT3	PACNT2	PACNT1	PACNT0
0x0064- 0x006B	Reserved	R W								
0x006C	OCPD	R W	OCPD7	OCPD6	OCPD5	OCPD4	OCPD3	OCPD2	OCPD1	OCPD0
0x006D	Reserved	R W								
0x006E	PTPSR	R W	PTPS7	PTPS6	PTPS5	PTPS4	PTPS3	PTPS2	PTPS1	PTPS0
0x006F	Reserved	R W								

0x0070–0x09F Analog to Digital Converter (ADC)

Address	Name		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
0x0070	ATDCTL0	R W	Reserved	0	0	0	WRAP3	WRAP2	WRAP1	WRAP0		
0x0071	ATDCTL1	R W	ETRIGSEL	SRES1	SRES0	SMP_DIS	ETRIGCH 3	ETRIGCH 2	ETRIGCH 1	ETRIGCH 0		
0x0072	ATDCTL2	R W	0	AFFC	Reseved	ETRIGLE	ETRIGP	ETRIGE	ASCIE	ACMPIE		
0x0073	ATDCTL3	R W	DJM	S8C	S4C	S2C	S1C	FIFO	FRZ1	FRZ0		
0x0074	ATDCTL4	R W	SMP2	SMP1	SMP0	PRS[4:0]						
0x0075	ATDCTL5	R W	0	SC	SCAN	MULT	CD	СС	СВ	CA		
0x0076	ATDSTAT0	R W	SCE	0	ETORF	FIFOR	CC3	CC2	CC1	CC0		
			001									
0x0077	Reserved	R W	0	0	0	0	0	0	0	0		
0x0078	ATDCMPEH	R		CMPE[15:8]								
		W										
0x0079	ATDCMPEL	R	CMPE[7:0]									
		W	····· –[····]									